

Accelerometers

for Restraint and Safety Systems

Bosch produces accelerometers for deployment of airbags since 1978. The first systems have been using piezoelectric ceramics sensing elements. Starting in 1997 a new generation of sensors is in volume production providing a low-cost solution with increased functionality. The sensing elements are manufactured using a unique and robust surface micro-machining technology that has been developed at Bosch. This process features a 10µm thick polysilicon layer used for the movable sensor structure. The proofmass and the electrodes are sealed on wafer level with a bulk micro-machined capping wafer. To minimize production costs the sensors are packaged in a standard plastic housing (PLCC28).

The SMB05x/06x/ series features:

- Standard SMD PLCC28 Packaging
- Self Test
- Automotive Temperature Range
- Ratiometric Output
- On-Chip 2 Pole Filter
- On-Chip Offset Adjustment

Crash Test with Deployment of Airbag

The SMB05x/06x accelerometers cover various
acceleration ranges and sensitivity axes:

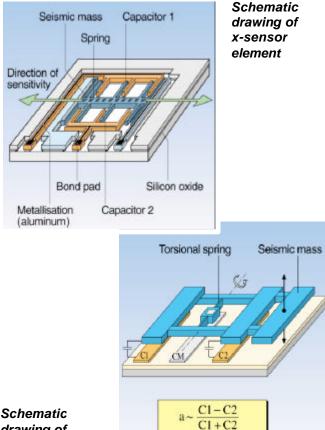
Туре	Range	Sensitivity Axes
SMB050		X (single axis)
SMB060	±35 g	X, Y (dual axis)
SMB065		X, -X (dual axis)
SMB052		X (single axis)
SMB062	±50 g	X, Y (dual axis)
SMB067		X, -X (dual axis)

Product Portfolio

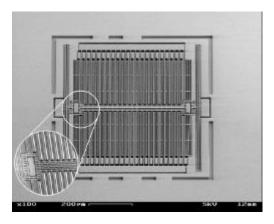
The SMB05x/06x series is part of a larger sensor portfolio based on a single manufacturing technology. The portfolio consists of the following sensors:

- Peripheral Airbag Sensors/Upfront Sensors SMB120/SMB170 with acceleration ranges of ±100 g and ±220 g
- Low-g sensor for various applications (e.g. inclination) SMB110 with acceleration range of ±1g
- Gyroscopes SMG040 and SMG045 for Rollover and Navigation applications with measurement range of ±250 °/s and ±75°/s
 - 2nd generation of acceleration sensors is scheduled for B2003. Features:
 - improved performance and pricing
 - smaller packaging (SOIC28)





drawing of z-sensor element



Details of micromachined sensing element

Robert Bosch GmbH

Department AE/VKF

Fax: +49 7121 35-21 70

Automotive.Electronics@de.bosch.com

Post box 1342

72703 Reutlingen Tel.: +49 7121 35-6652

For further information:

Working Principle

The common sensing principle of the accelerometers is capacitive. An acceleration in the lateral direction deflects the proof mass that is suspended by folded springs in the x-sensing element. One set of electrodes is attached to the proof mass and moves with acceleration. These movable electrodes form capacitors with two sets of fixed electrodes opposing them with a small air gap in between. The use of such a differential capacitive arrangement with two capacitors reduces the nonlinearity of the transfer function of the device. Over-range stops are implemented for shock protection that avoid the direct contact of the fingers at large accelerations. The mechanical sensitivity (in fF/g) can be adjusted by the thickness and/or the length of the springs.

The z-axis element uses a proof mass with an offcenter point of gravity. Any acceleration in the vertical direction will result in a tilt of the proof mass and a change in the differential capacitor.

The differential capacitance signal is evaluated by an ASIC which is electrically connected to the sensor by chip-to-chip wire bonds. A change of C_1 and C_2 is detected and transformed into a corresponding analog voltage by a capacitance/ voltage converter

Parameter	Min.	Nomi- nal	Max.	Unit
Supply Voltage	4.75	5	5.25	V
Supply Current Single Channel Dual Channel		6 12	7 14	mA mA
Tolerance of Sensitivity		5	9	%
Nonlinearity of Sensitivity		0.8	2	%
Cross Axis Sensitivity			5	%
3db Corner Frequency	320	400	480	Hz

Robert Bosch Corporation Automotive Groupe(AB/SFO3) 38000 Hills Tech Drive Farmington Hills, MI 48331-3417 Tel.: +1 248 5 53-13 90 Fax: +1 248 5 53-7926 Robert Bosch K.K. Bosch Technical Center 9-1, Ushikubo 3-chome Tsuzuki-ku, Yokohama 224 Tel.: +81 45 9 12-83 01 Fax: +81 45 9 12-95 73

[©] All rights reserved by Robert Bosch GmbH including the right to file industrial property rights. Robert Bosch GmbH retains the sole powers of disposition, such as reproduction, copying, and distribution rights.